

Solid State Relay OCMOS FET

PS7122A-1B,-2B,PS7122AL-1B,-2B

6, 8-PIN DIP, 250 V BREAK DOWN VOLTAGE NORMALLY CLOSE TYPE 1-ch, 2-ch Optical Coupled MOS FET

-NEPOC Series-

DESCRIPTION

The PS7122A-1B, -2B and PS7122AL-1B, -2B are solid state relays containing GaAs LEDs on the light emitting side (input side) and normally close (N.C.) contact MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7122AL-1B, -2B have a surface mount type lead.

FEATURES

- 1 channel type (1 b output) or 2 channel type (1 b + 1 b output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small package (6, 8-pin DIP)
- Low offset voltage
- Ordering number of taping product : PS7122AL-1B-E3, E4: 1 000 pcs/reel
 - : PS7122AL-2B-E3, E4: 1 000 pcs/reel

<R> • Pb-Free product

- Safety standards
 - UL approved: File No. E72422
 - BSI approved: No. 8245/8246
 - CSA approved: No. CA 101391

APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

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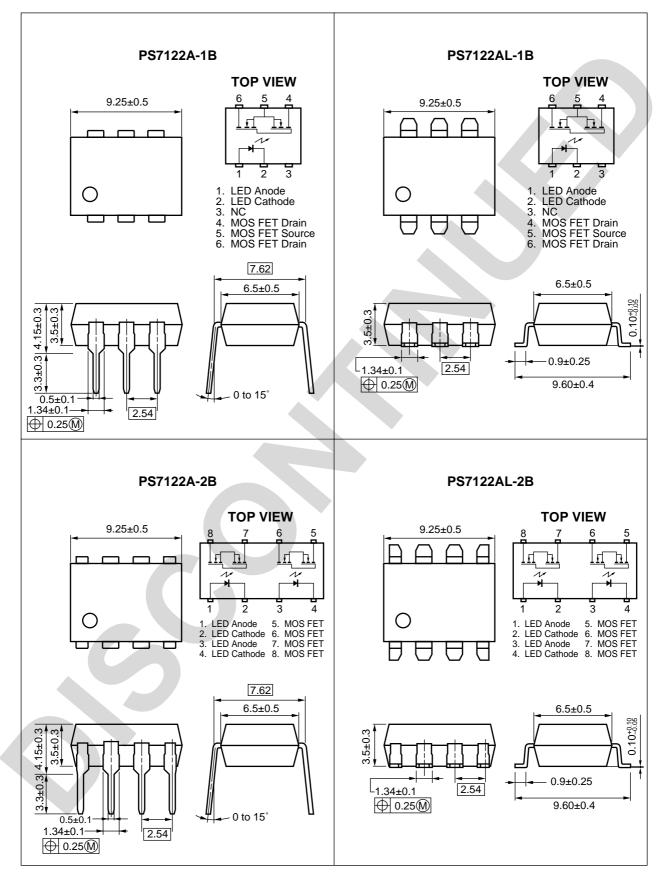
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The mark <R> shows major revised points.

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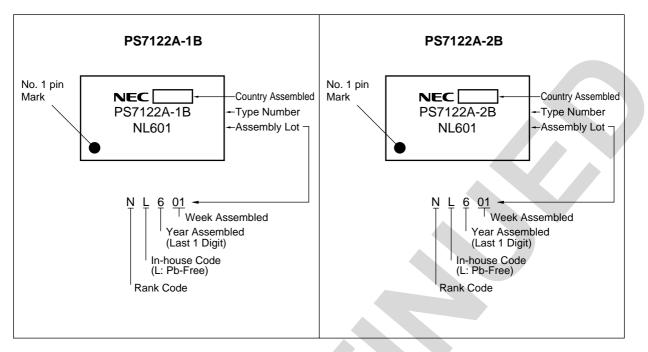
The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (in millimeters)



Data Sheet PN10274EJ02V0DS

<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number ^{*1} |
|----------------|------------------|---------------------------------|------------------------------|-----------------------------|--|
| PS7122A-1B | PS7122A-1B-A | Pb-Free | Magazine case 50 pcs | Standard products | PS7122A-1B |
| PS7122AL-1B | PS7122AL-1B-A | | | (UL, BSI, CSA | |
| PS7122AL-1B-E3 | PS7122AL-1B-E3-A | | Embossed Tape 1 000 pcs/reel | approved) | |
| PS7122AL-1B-E4 | PS7122AL-1B-E4-A | | | | |
| PS7122A-2B | PS7122A-2B-A | | Magazine case 50 pcs | | PS7122A-2B |
| PS7122AL-2B | PS7122AL-2B-A | | | | |
| PS7122AL-2B-E3 | PS7122AL-2B-E3-A | | Embossed Tape 1 000 pcs/reel | | |
| PS7122AL-2B-E4 | PS7122AL-2B-E4-A | | | | |

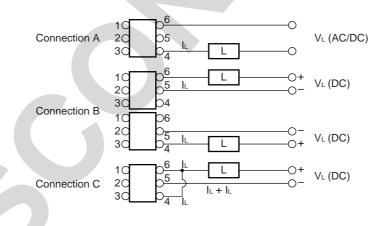
*1 For the application of the Safety Standard, following part number should be used.

| | | | | Ratings | | |
|-------------------------------|--|-------------------|--------|----------------------------|----------------------------|---------|
| Parameter | | | Symbol | PS7122A-1B, PS7122AL-1B | PS7122A-2B, PS7122AL-2B | Unit |
| Diode | Forward Current (D | C) | lf | 50 | | mA/ch |
| | Reverse Voltage | | Vr | 5.0 | | V |
| | Power Dissipation | | PD | 50 | | mW/ch |
| | Peak Forward Curre | ent ^{*1} | IFP | 1 | | A/ch |
| MOS FET | MOS FET Break Down Voltage | | VL | 250 | | V |
| | Continuous | Connection A | ١L | 200 | | mA/ch |
| | Load Current *2 | Connection B | | 350 | - | |
| | | Connection C | | 500 | - | |
| | Pulse Load Current ^{*3} (AC/DC Connection) | | Ilp | 400 | | mA/ch |
| Power Dissipation | | PD | 560 | 375 | mW/ch | |
| Isolation Voltage *4 | | | BV | 1 500 | | Vr.m.s. |
| Total Power Dissipation | | | Р⊤ | 610 | 850 | mW |
| Operating Ambient Temperature | | | TA | -40 to +85 | | °C |
| Storage Temperature | | | Tstg | -40 to +100 | | °C |

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

*1 PW = 100 *µ*s, Duty Cycle = 1%

*2 Conditions: IF \geq 2 mA. The following types of load connections are available.



*3 PW = 100 ms, 1 shot

*4 AC voltage for 1 minute at $T_A = 25^{\circ}C$, RH = 60% between input and output

Pins 1-3 shorted together, 4-6 shorted together. (PS7122A-1B)

Pins 1-4 shorted together, 5-8 shorted together. (PS7122A-2B)

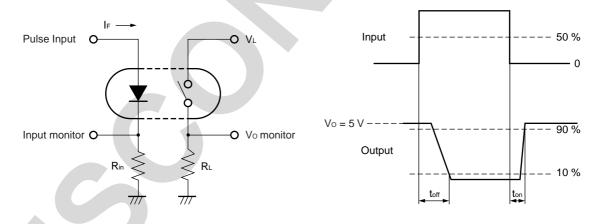
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|-----------------------|--------|------|------|------|------|
| LED Operating Current | lF | 2 | 10 | 20 | mA |
| LED Off Voltage | VF | 0 | | 0.5 | V |

ELECTRICAL CHARACTERISTICS (TA = 25°C)

| | Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|---------|-------------------------------|--------|--|-----------------|------|------|-------|
| Diode | Forward Voltage | VF | IF = 10 mA | | 1.2 | 1.4 | V |
| | Reverse Current | IR | V _R = 5 V | | | 5.0 | μA |
| MOS FET | Off-state Leakage Current | Loff | IF = 10 mA, VD = 250 V | | 0.03 | 1.0 | μA |
| | Output Capacitance | Cout | IF = 10 mA, VD = 0 V, f = 1 MHz | | 340 | | pF/ch |
| Coupled | LED Off-state Current | Foff | I∟ = 200 mA | | | 2.0 | mA |
| | On-state Resistance | Ron1 | I⊧ = 0 mA, I∟ = 10 mA | | 4.5 | 8.0 | Ω |
| | | Ron2 | $I_F=0 \text{ mA}, \ I_L=200 \text{ mA}, \ t \leq 10 \text{ ms}$ | | | | |
| | Turn-on Time ^{*1, 2} | ton | I⊧ = 10 mA, V₀ = 5 V, R⊾ = 500 Ω, | | 0.04 | 0.2 | ms |
| | Turn-off Time *1, 2 | toff | PW ≥ 10 ms | | 0.5 | 1.5 | |
| | Isolation Resistance | Ri-o | VI-O = 1.0 kVDC | 10 ⁹ | | | Ω |
| | Isolation Capacitance | CI-O | V = 0 V, f = 1 MHz | | 1.1 | | pF/ch |

*1 Test Circuit for Switching Time



<R>

*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

75⁸⁵

f = 1 MHz

100

 $I_F = 0 \text{ mA}$

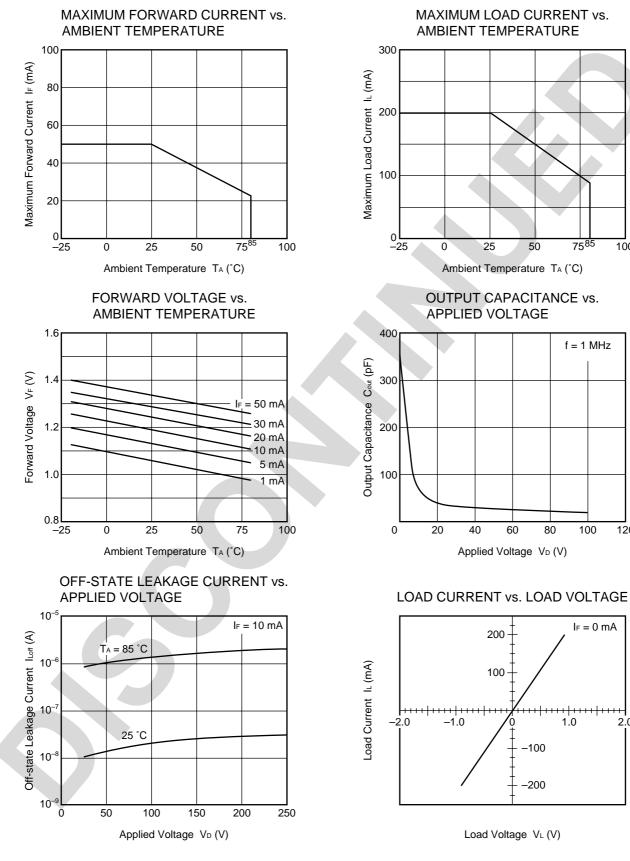
1.0

120

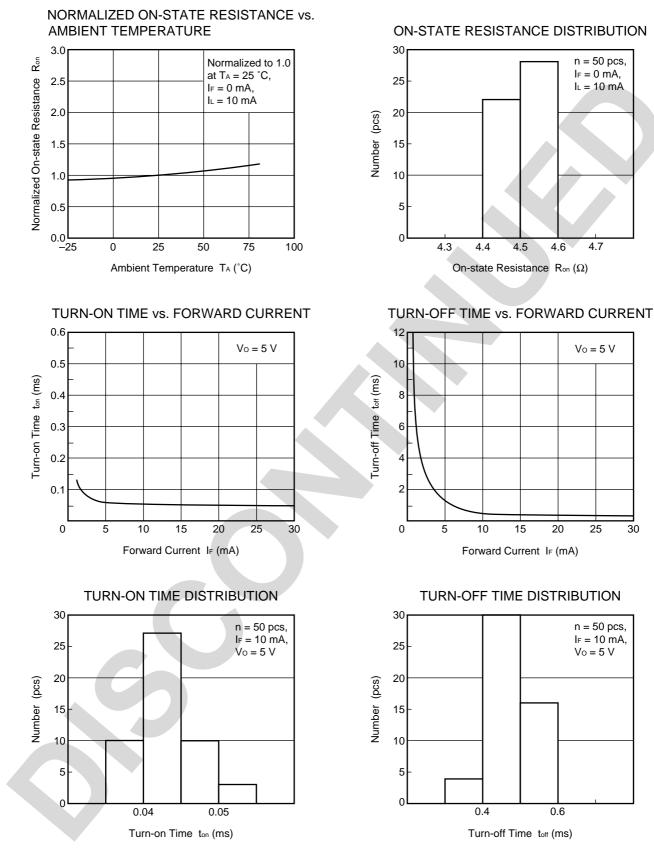
2.0

100

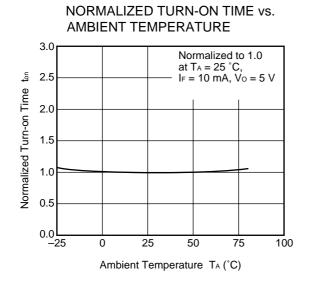
TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

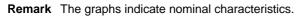


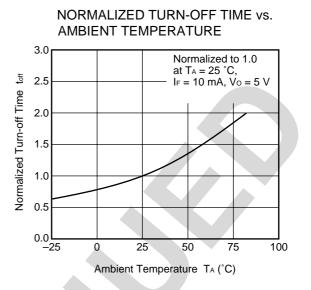
Remark The graphs indicate nominal characteristics.



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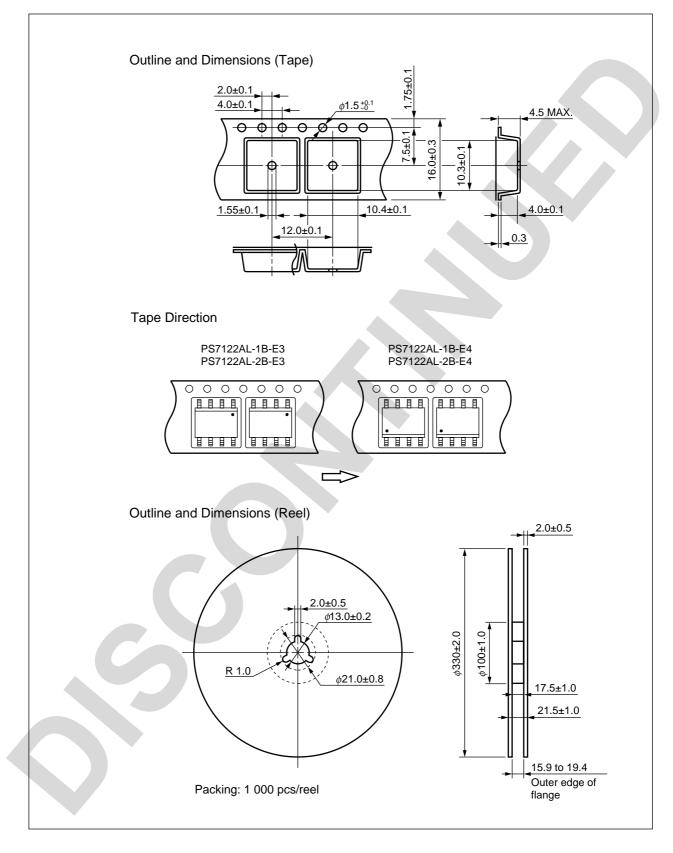






Data Sheet PN10274EJ02V0DS

TAPING SPECIFICATIONS (in millimeters)

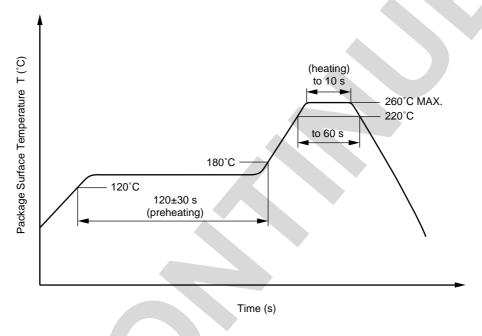


RECOMMENDED SOLDERING CONDITIONS

- (1) Infrared reflow soldering
 - · Peak reflow temperature
 - Time of peak reflow temperature
 - Time of temperature higher than 220°C
 - Time to preheat temperature from 120 to 180°C
 - Number of reflows
 - Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature
- Time
- 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature) One
- Number of times
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

<R> (3) Soldering by soldering iron

| Peak temperature (lead part temperature) | 350°C or below |
|--|---|
| Time (each pins) | 3 seconds or less |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a |
| | maximum chlorine content of 0.2 Wt% is recommended.) |

260°C or below (molten solder temperature)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> USAGE CAUTIONS

- **1.** Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

| Caution GaAs Products | This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. |
|-----------------------|---|
| | • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. |
| | Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. |
| | 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. |
| | • Do not burn, destroy, cut, crush, or chemically dissolve the product. |
| | Do not lick the product or in any way allow it to enter the mouth. |

For further information, please contact

NEC Compound Semiconductor Devices Hong Kong Limited E-mail: contact@ncsd-hk.necel.com

Hong Kong Head Office TEL: +852-3107-7303 Taipei Branch Office Korea Branch Office

TEL: +82-2-558-2120

FAX: +852-3107-7309 TEL: +886-2-8712-0478 FAX: +886-2-2545-3859 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH http://www.eu.necel.com/ TEL: +49-211-6503-0 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. http://www.cel.com/ TEL: +1-408-988-3500 FAX: +1-408-988-0279

Compound Semiconductor Devices Division NEC Electronics Corporation URL: http://www.ncsd.necel.com/



4590 Patrick Henry Drive Santa Clara, CA 95054-1817 Telephone: (408) 919-2500 Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

| Restricted Substance per RoHS | Concentration Limit per RoHS (values are not yet fixed) | Concentration contained in CEL devices | | |
|----------------------------------|---|---|------------|--|
| Lead (Pb) | < 1000 PPM | -A Not Detected | -AZ (*) | |
| Mercury | < 1000 PPM | Not De | etected | |
| Cadmium | < 100 PPM | Not De | etected | |
| Hexavalent Chromium | < 1000 PPM | Not De | etected | |
| РВВ | < 1000 PPM | Not De | etected | |
| PBDE | < 1000 PPM | Not De | etected | |

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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